

Technical Data Sheet

1206 Package Chip LED (1.0mm Height)

15-21/T1D-APQHY/2T

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version.

Descriptions

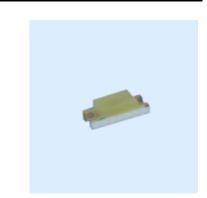
- The 15-21 SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

Device Selection Guide

D. AN.	Chip	E '44 LC.L.	Resin Color	
Part No.	Material	Emitted Color		
15-21/T1D-APQHY/2T	InGaN	Pure White	Yellow Diffused	



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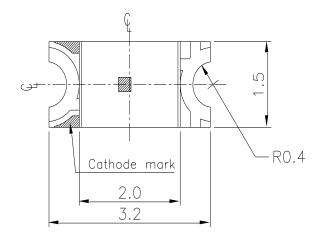
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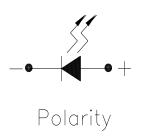
Device No:

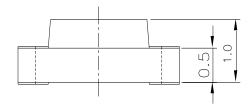


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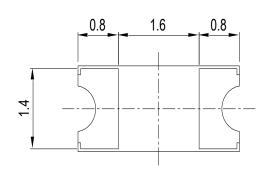
Package Outline Dimensions

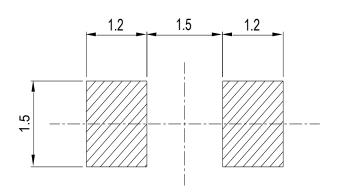






Recommend Sodering Pad





Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

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Absolute Maximum Ratings (Ta=25℃)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	V_R	5	V	
Forward Current	$ m I_F$	25	mA	
Peak Forward Current (Duty 1/10 @1KHz)	${ m I_{FP}}$	100	mA	
Power Dissipation	Pd	95	mW	
Electrostatic Discharge(HBM)	ESD	150	V	
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\!\mathbb{C}$	
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}\!\mathbb{C}$	
Soldering Temperature	Tsol	Reflow Soldering: 260 °C for 10 sec. Hand Soldering: 350 °C for 3 sec.		

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	Iv	45		112	mcd	
Viewing Angle	2 \theta 1/2		140		deg	I _F =5mA
Forward Voltage	V_{F}	2.70		3.15	V	
Reverse Current	I_R			50	μ A	V _R =5V

Notes:

1.Tolerance of Luminous Intensity ±11%

2.Tolerance of Forward Voltage ±0.1V

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Bin Range Of Luminous Intensity

Bin	Min	Max	Unit	Condition
P	45	72	mcd	I _F =5mA
Q	72	112		

Bin Range Of Forward Voltage

Group	Bin	Min	Max	Unit	Condition
Group	DIII	171111	IVIAA	Omt	Condition
	15	2.70	2.85		
Н	16	2.85	3.00	V	I _F =5mA
	17	3.00	3.15		

Notes:

- 1.Tolerance of Luminous Intensity ±11%
- 2.Tolerance of Forward Voltage ±0.1V

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Chromaticity Coordinates Specifications for Bin Grading

Groups	Bin Code	CIE_x	CIE_ y	Condition
		0.274	0.226	
	1	0.274	0.258	
	1	0.294	0.286	
		0.294	0.254	
		0.274	0.258	
	2	0.274	0.291	
	2	0.294	0.319	
		0.294	0.286	
		0.294	0.254	
	2	0.294	0.286	
	3	0.314	0.315	
A		0.314	0.282	Ι 5 Α
A	4	0.294	0.286	I _F =5mA
		0.294	0.319	
		0.314	0.347	
		0.314	0.315	
	5	0.314	0.282	
		0.314	0.315	
		0.334	0.343	
		0.334	0.311	
	6	0.314	0.315	
		0.314	0.347	
		0.334	0.376	
		0.334	0.343	

Notes:

- 1.The C.I.E. 1931 chromaticity diagram (Tolerance ± 0.01).
- 2. The products are sensitive to static electricity and care must be fully taken when handling products.

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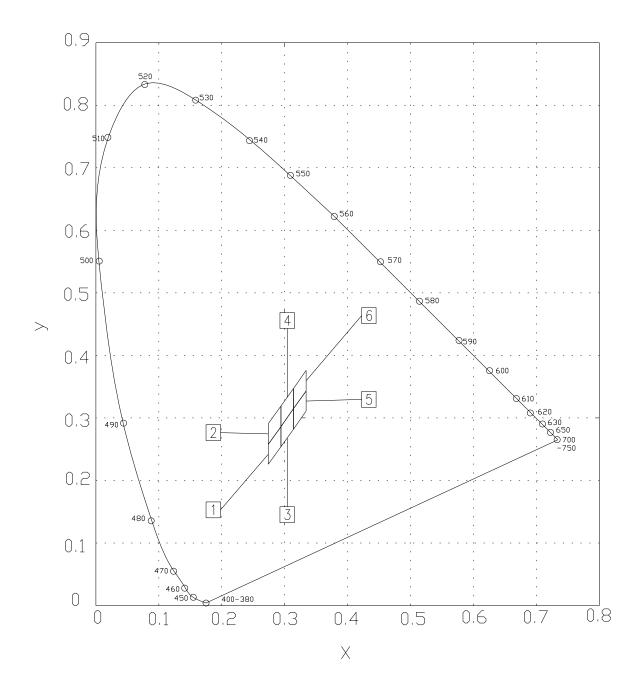
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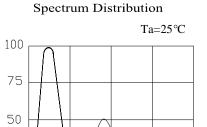
CIE Chromaticity Diagram

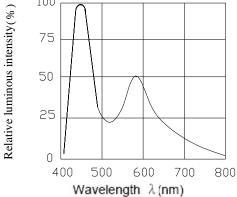


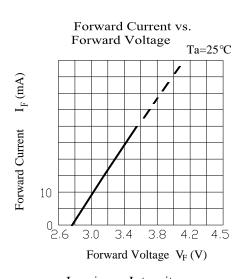
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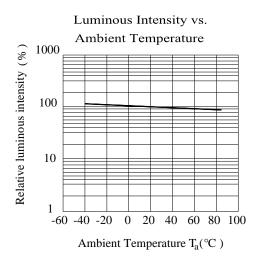
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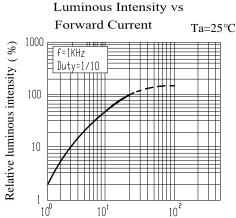
Typical Electro-Optical Characteristics Curves



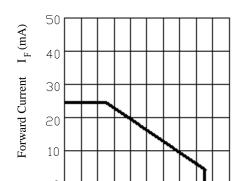








Forward Current I_F (mA)



40

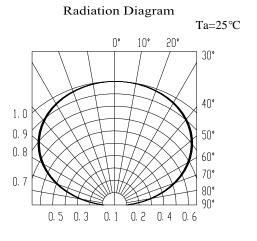
60

Ambient Temperature T_a (°C)

85

100

Forward Current Derating Curve





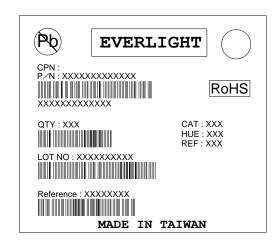
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Label explanation

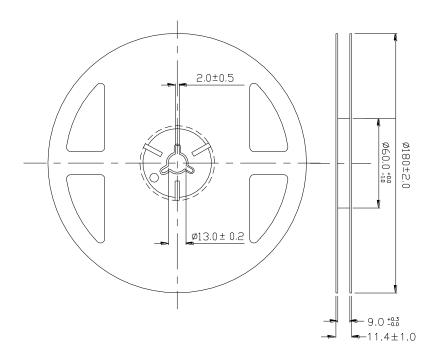
CAT: Luminous Intensity Rank

HUE: Chromaticity Coordinates

REF: Forward Voltage Rank



Reel Dimensions

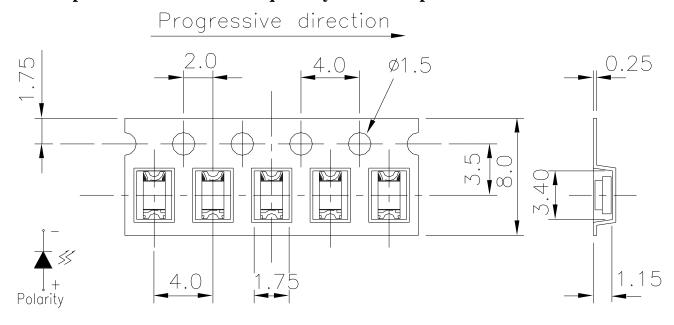


Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm



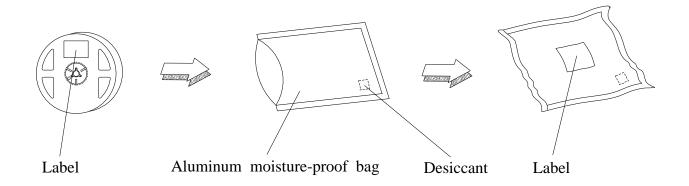
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Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Moisture Resistant Packaging



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Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min \int 5 min $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	$H: +100^{\circ}\mathbb{C}$ 5min $\int 10 \sec$ $L: -10^{\circ}\mathbb{C}$ 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°C	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85%RH	1000 Hrs.	22 PCS.	0/1

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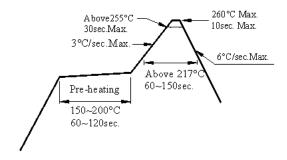
Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30° C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

 Baking treatment: 60±5°C for 24 hours..
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

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ul-2011 Prepared by: Chen Zheng



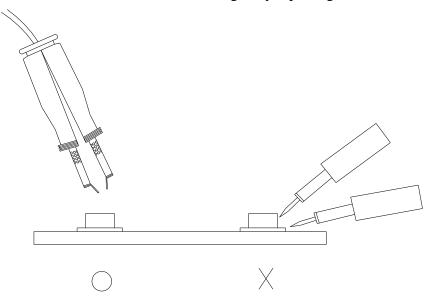
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4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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